

DATA SHEET

ARRAY CHIP RESISTORS

YC 158/358 (10Pin/8R)

5%

sizes 0612/1225

RoHS compliant



YAGEO Phicomp



SCOPE

This specification describes YC158/358 series chip resistor network with lead-free terminations made by thick film process.

APPLICATIONS

- Terminal for SDRAM and DDRAM
- Computer applications: laptop computer, desktop computer
- Consume electronic equipment: PDAs, PNDs
- Mobile phone, telecom...

FEATURES

- RoHS compliant
 - Products with lead free terminations meet RoHS requirements
 - Pb-glass contained in electrodes
 - Resistor element and glass are exempted by RoHS
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production
- Halogen Free Epoxy

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

YC 158/358 X X X X XX XXX L (1) (2) (3) (4) (5) (6) (7

(I) SCHEMATIC

L = L-type (for YC358)

T = T-type (for YCI58/358)

(2) TOLERANCE

 $| = \pm 5\%$

(3) PACKAGING TYPE

R = Paper taping reel (YC158)

K = Embossed taping reel (YC358)

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07 = 7 inch dia, Reel

13 = 13 inch dia, Reel

(6) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) OPTIONAL CODE

L = optional symbol (Note)

Resistance rule of global part number

Resistance code ru	le Example
XRXX (1 to 9.76 Ω)	IR = I Ω IR5 = I.5 Ω 9R76 = 9.76 Ω
XXRX (10 to 97.6 Ω)	IOR = IO Ω 97R6 = 97.6 Ω
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (1 to 9.76 KΩ)	1K = 1,000 Ω $9K76 = 9760 Ω$
XMXX (1 to 9.76 MΩ)	$IM = 1,000,000 \Omega$ $9M76 = 9,760,000 \Omega$

ORDERING EXAMPLE

The ordering code of a YC158/358T T-type chip resistor network, value 1,000 Ω with $\pm 5\%$ tolerance, supplied in 7-inch tape reel is: YC158/358TJR-071K(L).

NOTE

- All our RSMD products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / I2NC can be added (both are on customer request)



PHYCOMP BRAND ordering codes

Both GLOBAL PART NUMBER (preferred) and I2NC (traditional) codes are acceptable to order Phycomp brand products.

GLOBAL PART NUMBER (PREFERRED)

For detailed information of GLOBAL PART NUMBER and ordering example, please refer to page 2.

12NC CODE----

2350	XXX	XXXXX	
(1)	(2	(3)	(4)

EMBOSSED TAPE ON REEL(units) (2)	APE ON REEL (units) (2)	PAPER / PE TA	RESISTANCE	TOL.		TYPE	SIZE
4,000	20,000	5,000	RANGE	(%)	IN ⁽¹⁾		
	230 I2xxx	230 10xxx	10 to 100 K Ω	±5%	2350	RNA310	0612
200 l0xxx			10 to 330 K Ω	±5%	2350	YC358L	1225
201 I0xxx			10 to 330 K Ω	±5%	2350	YC358T	1225

- (1) The resistors have a 12-digit ordering code starting with 2350.
- (2) The subsequent 4 or 5 digits indicate the resistor tolerance and packaging.
- (3) The remaining 4 or 3 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of 12NC".
- (4) "L" is optional symbol (Note).

ORDERING EXAMPLE

The ordering code of a RNA310/YC358T T-type chip resistor network, value 1,000 Ω with ±5% tolerance, supplied in tape of 10,000 units per reel is: 235023010102(L) / 235020110102(L) or YC158/358TJR-071K (L).

NOTE

- I. All our RSMD products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / I2NC can be added (both are on customer request)

Last digit of 12NC	
Resistance decade (3)	Last digi
0.01 to 0.0976 Ω	(
0.1 to 0.976 Ω	-
I to 9.76 Ω	8
10 to 97.6 Ω	Ç
100 to 976 Ω	
I to 9.76 KΩ	2
10 to 97.6 KΩ	3
100 to 976 KΩ	2
I to 9.76 MΩ	Į.
10 to 97.6 MΩ	6

Example:	0.02 Ω	=	0200 or 200
	0.3 Ω	=	3007 or 307
	ΙΩ	=	1008 or 108
	33 KΩ	=	3303 or 333
	Ι0 ΜΩ	=	1006 or 106

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MARKING

YC158

YC358





E-24 series: 3 digits

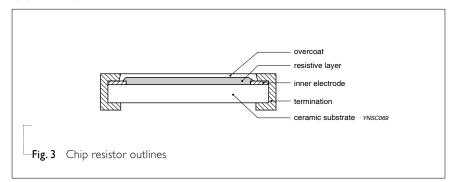
First two digits for significant figure and 3rd digit for number of zeros

For further marking information, please see special data sheet "Chip resistors marking".

CONSTRUCTION

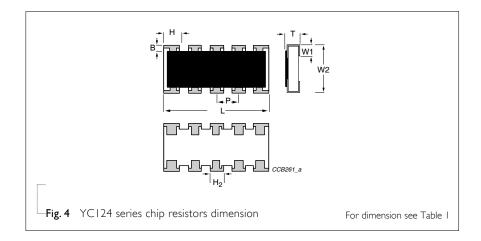
The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added. See fig.3

OUTLINES

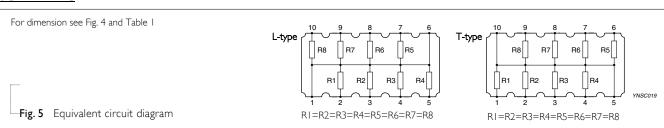


DIMENSIONS

Table I		
TYPE	YCI58	YC358
B (mm)	0.30 ±0.15	0.50 ±0.15
H (mm)	0.45 ±0.05	1.10 ±0.15
P (mm)	0.64 ±0.05	1.27 ±0.05
L (mm)	3.20 ±0.20	6.40 ±0.20
T (mm)	0.60 ±0.10	0.60 ±0.10
W_1 (mm)	0.35 ±0.15	0.50 ±0.15
W ₂ (mm)	1.60 ±0.15	3.20 ±0.20



SCHEMATIC



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ELECTRICAL CHARACTERISTICS

Table 2

CHARACTERISTICS		YC158 1/16 W	YC358 I/I6 W
Operating Temperature Range		-55 °C to +155 °C	–55 °C to +155 °C
Maximum Working Voltage		25 V	50 V
Maximum Overload Voltage		50 V	100 V
Dielectric Withstanding Voltage		50 V	100 V
Resistance Range	5% (E24)	10 Ω to 100 K Ω	I0 Ω to 330 K Ω
Temperature Coefficient		±200 ppm/°C	±200 ppm/°C

FOOTPRINT AND SOLDERING **PROFILES**

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	YCI58	YC358
Paper/PE taping reel (R)	7" (178 mm)	5,000	
	13" (330 mm)	20,000	
Embossed taping reel (K)	7" (178 mm)		4,000

NOTE

1. For Paper/Embossed tape and reel specification/dimensions, please see the special data sheet "Chip resistors packing".

FUNCTIONAL DESCRIPTION

POWER RATING

YC158/358 rated power at 70 °C is 1/16 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

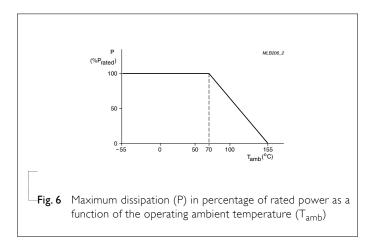
or max. working voltage whichever is less

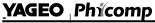
Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)





Chip Resistor Surface Mount YC SERIES 158/358 (RoHS Compliant)

TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Operational Life/ Endurance	MIL-STD-202G-method 108A IEC 60115-1 4.25.1 JIS C 5202-7.10	I,000 hours at 70±5 °C applied RCWV I.5 hours on, 0.5 hour off, still air required	±(2%+0.05 Ω)
High Temperature Exposure/ Endurance at upper category temperature	MIL-STD-202G-method 108A IEC 60115-1 4.25.3 JIS C 5202-7.11	I,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: I55±3 °C	±(1%+0.05 Ω)
Moisture Resistance	MIL-STD-202G-method 106F IEC 60115-1 4.24.2	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(2%+0.05 Ω)
		Parts mounted on test-boards, without condensation on parts	
		Measurement at 24±2 hours after test conclusion	
Thermal Shock	MIL-STD-202G-method 107G	-55/+155 °C	$\pm (0.5\% \pm 0.05~\Omega)$ for 10 K Ω to 10 M Ω
		Note: Number of cycles required is 300. Devices unmounted	$\pm (1\% + 0.05 \Omega)$ for others
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	
Short time	MIL-R-55342D-para 4.7.5	2.5 times RCWV or maximum overload voltage	±(2%+0.05 Ω)
overload	IEC60115-1 4.13	whichever is less for 5 sec at room temperature	No visible damage
Board Flex/	IEC60115-1 4.33	Device mounted on PCB test board as described,	±(1%+0.05 Ω)
Bending		only I board bending required	No visible damage
		3 mm bending	
		Bending time: 60±5 seconds	
		Ohmic value checked during bending	



Chip Resistor Surface Mou	l Yo
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C SERIES 158/358 (RoHS Compliant)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	IPC/JEDECJ-STD-002B test B IEC 60068-2-58	Electrical Test not required Magnification 50X SMD conditions: Ist step: method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	Well tinned (≥95% covered) No visible damage
- Leaching	IPC/JEDECJ-STD-002B test D IEC 60068-2-58	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	MIL-STD-202G-method 210F IEC 60068-2-58	Condition B, no pre-heat of samples Leadfree solder, 270 °C, 10 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	$\pm (1\% + 0.05 \ \Omega)$ No visible damage

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 3	Nov 14, 2008	-	- New datasheet for YC158 and YC358 thick film 5% with lead-free terminations
			- Replace the YC158 and YC358 part of pdf files: Pu-YC158_5_PbFree_L_2.pdf, Yu-YC158_5_PbFree_L_2.pdf, Pu-YC358_5_PbFree_L_0.pdf and Yu-YC358_5_PbFree_L_0.pdf
			- Description of "Halogen Free Epoxy" added
			- Define global part number
Version 2	Feb 22, 2005	-	- Test method and procedure updated
Version I	Apr. 22, 2004	-	- Added 13" taping and Jumper, deleted G in ordering code, and test & requirement (Pb free) update
Version 0	Nov. 10, 2003	-	- First issue of this specification

[&]quot;Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."